GL150N15A47

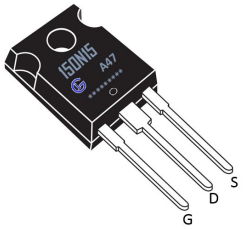
GL Silicon N-Channel Power MOSFET

General Description

The GL150N15A47 uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications. The package form is TO-247, which accords with the RoHS standard.

V_{DSS}	150	V
I_D	150	A
P_D	370	W
$R_{DS(ON)type}$	5.5	mΩ

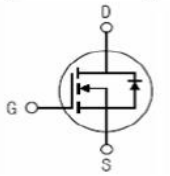
TO-247



Features

- $R_{DS(ON)}$ <6.5mΩ @ V_{GS}=10V (Typ5.5mΩ)
- High density cell design for ultra low R_{dson}
- Fully characterized avalanche voltage and current
- Excellent package for good heat dissipation

Inner Equivalent Principium Chart



Applications

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

Absolute (Tc= 25℃ unless otherwise specified)

Symbol	Parameter	Rating	Units
V_{DSS}	Drain-to-Source Voltage	150	V
I_D	Continuous Drain Current	150	A
I_{DM}	Pulsed Drain Current	450	A
V_{GS}	Gate-to-Source Voltage	±20	V
P_D	Power Dissipation	370	W
E_{AS}	Single pulse avalanche energy[a5]	1600	mJ
T_J, T_{stg}	Operating Junction and Storage Temperature Range	175, −55 to 175	℃

Caution Stresses greater than those in the "Absolute Maximum Ratings" may cause permanent damage to the device

Thermal Characteristics

Symbol	Parameter	Typ.	Units
$R_{\theta JC}$	Junction-to-Case[a2]	0.41	℃/W

Electrical Characteristics (Tc= 25℃ unless otherwise specified)

OFF Characteristics						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
V_{DSS}	Drain to Source Breakdown Voltage	V_{GS}=0V,I_D=250μA	150	--	--	V
I_{DSS}	Drain to Source Leakage Current	V_{DS}=150V,V_{GS}=0V,T_a=25℃	--	--	1.0	μA
$I_{GSS(F)}$	Gate to Source Forward Leakage	V_{GS}=+20V	--	--	0.1	μA
$I_{GSS(R)}$	Gate to Source Reverse Leakage	V_{GS}=-20V	--	--	-0.1	μA

ON Characteristics[a3]						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
$R_{DS(ON)}$	Drain-to-Source On-Resistance	V_{GS}=10V,I_D=75A	--	5.5	6.5	mΩ
$V_{GS(TH)}$	Gate Threshold Voltage	V_{DS}=V_{GS},I_D=250μA	2.0	--	4.0	V
Pulse width tp≤380μs,δ≤2%						

Dynamic Characteristics[a4]						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
g_{fs}	Forward Transconductance	V_{DS}=25V,I_D=75A	65	--	--	S
C_{iss}	Input Capacitance	V_{GS}=0V,V_{DS}=25V f=1.0MHz	--	6000	--	pF
C_{oss}	Output Capacitance		--	650	--	
C_{rss}	Reverse Transfer Capacitance		--	10	--	

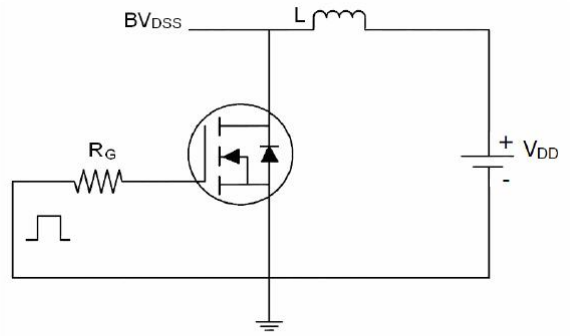
Resistive Switching Characteristics[a4]						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
$t_{d(ON)}$	Turn-on Delay Time	V_{DD}=75V,I_D=75A,R_L=15Ω V_{GS}=10V,R_G=4.7Ω	--	26	--	ns
t_r	Rise Time		--	36	--	
$t_{d(OFF)}$	Turn-Off Delay Time		--	48	--	
t_f	Fall Time		--	16	--	
Q_g	Total Gate Charge	V_{DD}=75V,I_D=75A V_{GS}=10V	--	80	--	nC
Q_{gs}	Gate to Source Charge		--	33	--	
Q_{gd}	Gate to Drain (“Miller”)Charge		13	39	--	

Source-Drain Diode Characteristics						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
I_S	Continuous Source Current [a2](Body Diode)		--	--	150	A
V_{SD}	Diode Forward Voltage[a3]	I_S=150A,V_{GS}=0V	--	--	1.2	V

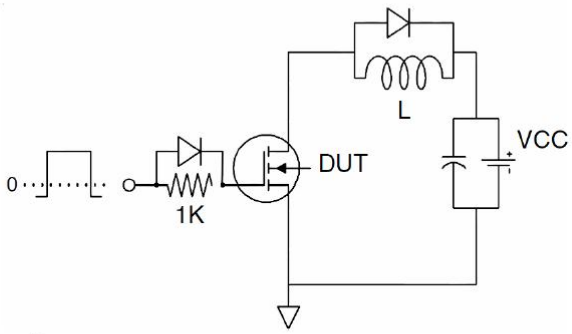
[a1]: Repetitive Rating: Pulse width limited by maximum junction temperature.
[a2]: Surface Mounted on FR4 Board, t≤10sec.
[a3]: Pulse Test: Pulse Width≤300μs, Duty Cycle≤2%.
[a4]: Guaranteed by design, not subject to production
[a5]: EAS condition: Tj=25℃,V_{DD}=40V,V_G=10V,L=0.5mH,Rg=25Ω

Test Circuits

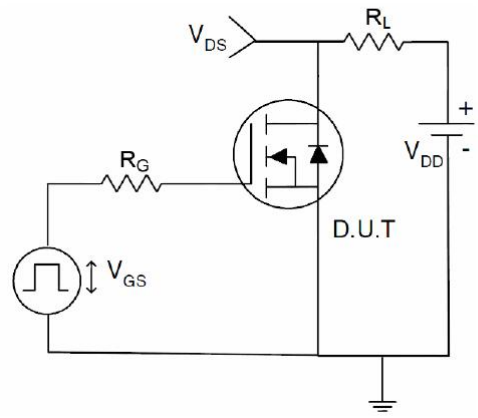
1) EAS test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit



Characteristics Curves

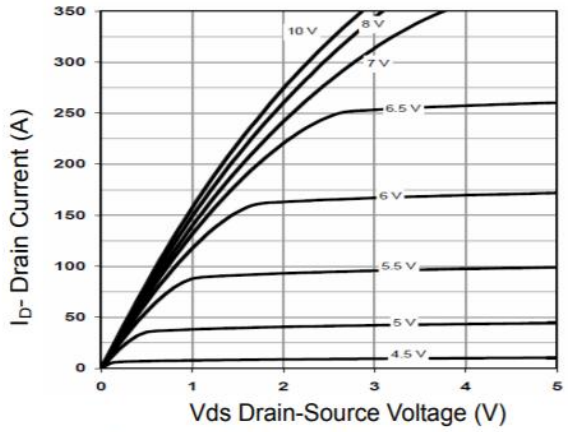


Figure 1 Output Characteristics

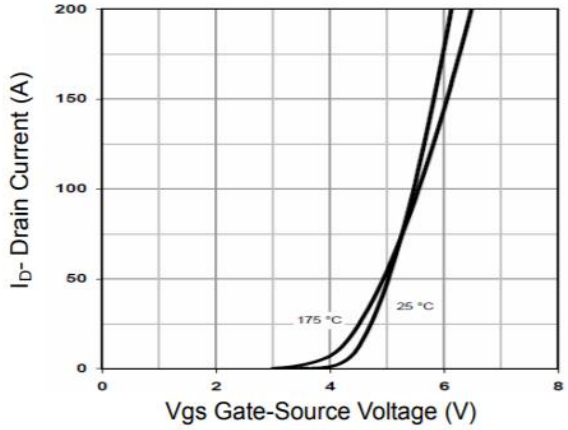


Figure 2 Transfer Characteristics

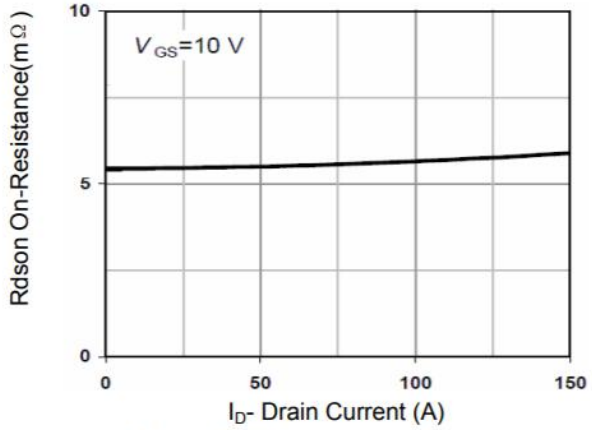


Figure 3 Rdson- Drain Current

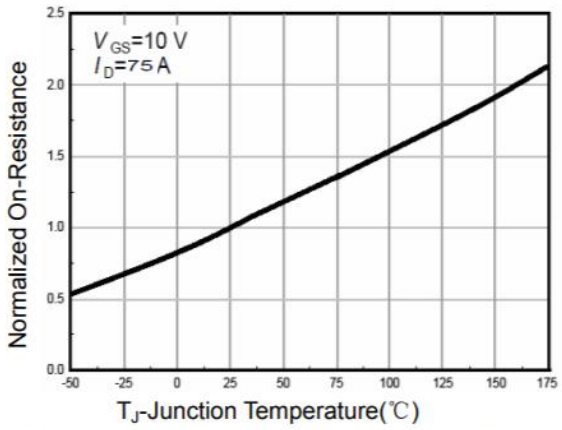


Figure 4 Rdson-JunctionTemperature

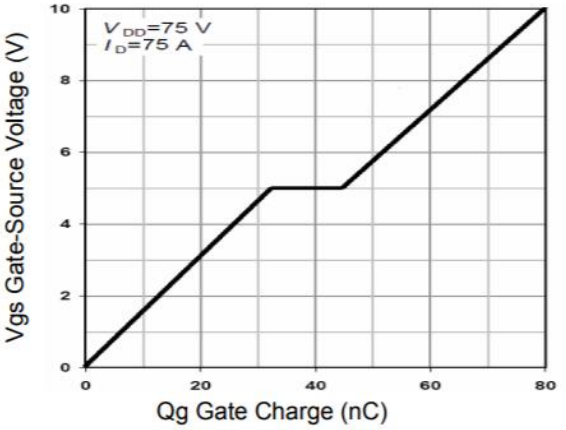


Figure 5 Gate Charge

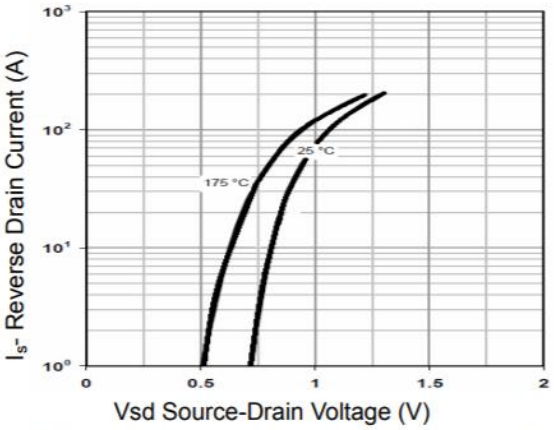


Figure 6 Source- Drain Diode Forward

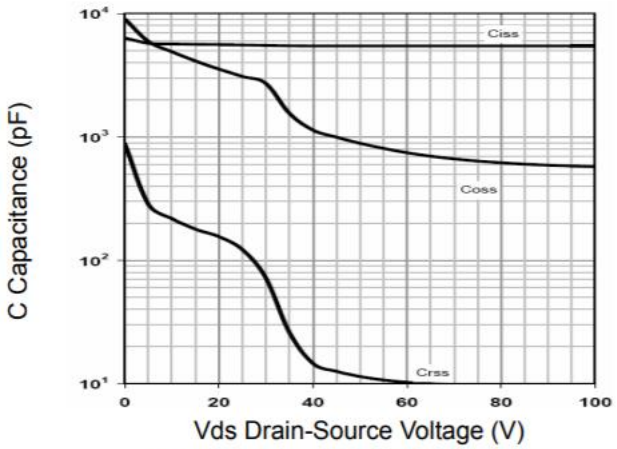


Figure 7 Capacitance vs Vds

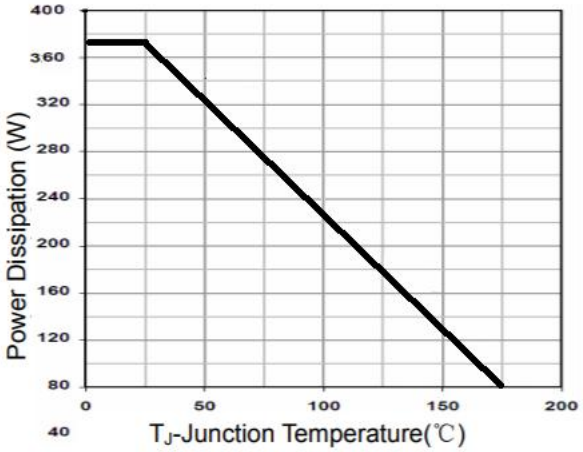


Figure 9 Power De-rating

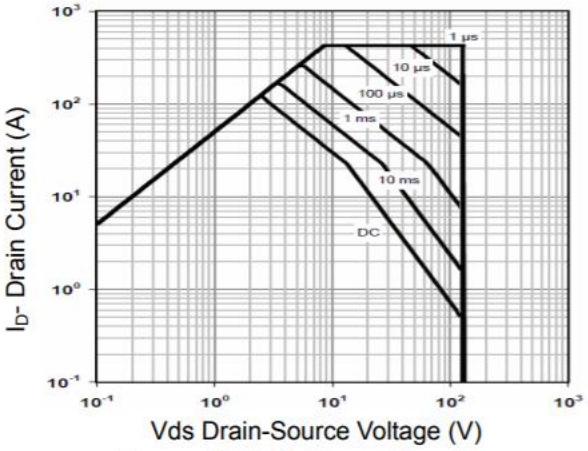


Figure 8 Safe Operation Area

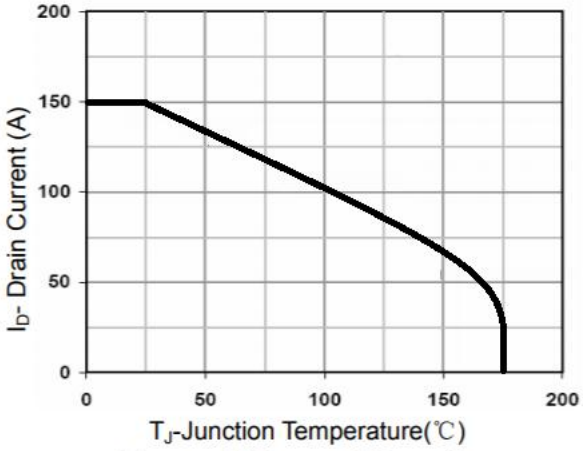


Figure 10 Current De-rating

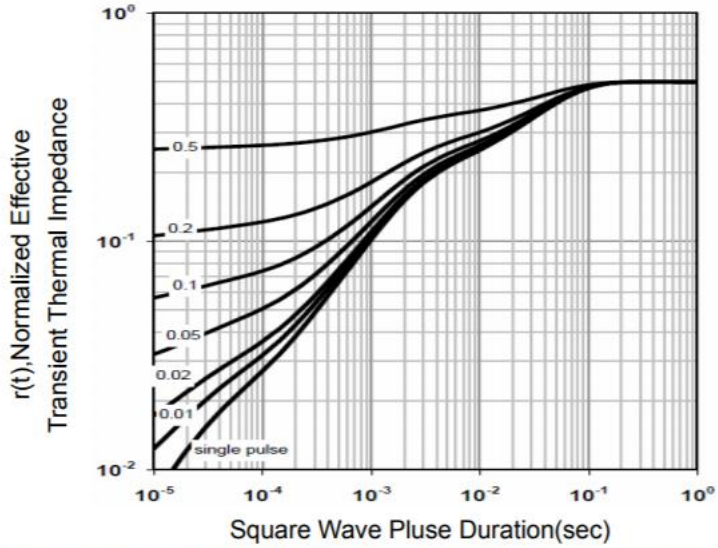


Figure 11 Normalized Maximum Transient Thermal Impedance